PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Josef Willer	05/27/2008
Michael Specht	05/27/2008
Christoph Friederich	05/27/2008
Doris Keitel-Schulz	05/28/2008

RECEIVING PARTY DATA

Name:	Qimonda Flash GmbH
Street Address:	Konigsbruckerstrasse 180
City:	Dresden
State/Country:	GERMANY
Postal Code:	01099

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12112379

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	5682-038

NAME OF SUBMITTER: Larry L. Coats

Total Attachments: 2

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PATENT REEL: 021121 FRAME: 0172

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ASSIGNMENT

For good and valuable consideration, I, Josef Willer, a citizen of Germany, residing at Friedrich-Froebel-Strasse 62, 85521 Riemerling, Germany, Michael Specht, a citizen of Germany, residing at Elilandstrasse 2, 81547 München, Germany, Christoph Friederich, a citizen of Germany, residing at Spalatinstrasse 16, 81739 München, Germany, and Doris Keitel-Schulz, a citizen of Germany, residing at Saglerstrasse 12, 85635 Höhenkirchen, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Qimonda Flash GmbH**, having its principal place of business at KönigsbrückerstraBe 180, 01099 Dresden, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on

4/30/2008

US. Serial No.

12/112,379

entitled: Method for Forming Trenches on a Surface of a Semiconductor Substrate

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

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DATE:

May 27, 2008

PATENT REEL: 021121 FRAME: 0174

CLIENT REF. S4275 SB/dlo C&B REF. 5682-038

SIGNATURE:

RECORDED: 06/19/2008

Doris Keitel-Schulz

DATE:

PATENT

REEL: 021121 FRAME: 0175